### AMPMODU | AMPMODU Headers

TE Internal #: 6-102567-3

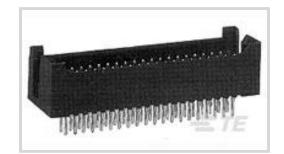
PCB Mount Header, Vertical, Board-to-Board, 30 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder,

AMPMODU Headers

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: **30**Number of Rows: **2** 

### **Features**

### **Product Type Features**

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Fully Shrouded
Connector & Contact Terminates To	Printed Circuit Board

## **Configuration Features**

PCB Mount Orientation	Vertical
Number of Positions	30
Number of Rows	2
Board-to-Board Configuration	Parallel

#### **Electrical Characteristics**

Termination Resistance	12 mΩ
Operating Voltage	250 VAC

### **Body Features**

Primary Product Color	Black	
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#### **Contact Features**

Mating Square Post Dimension	.64 mm[.025 in]
	100 μin
Contact Shape & Form	Square



PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Copper Alloy
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.381 μm[15 μin]
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	4.57 mm[.18 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Retention	Without
Mating Alignment	With
Mating Alignment Type	Guide Pins
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	Thermoplastic
Dimensions	
Connector Height	13.97 mm[.55 in]
Row-to-Row Spacing	2.54 mm[.1 in]
Stack Height	11.43 mm[.45 in]
PCB Thickness (Recommended)	1.4 mm[.055 in]
Usage Conditions	
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
	Board Standoff
Solder Process Feature	Doard Staridon
Solder Process Feature  Circuit Application	Signal



<b>UL</b> Flammability	/ Rating	UL 94V-0
	, Nathing	

#### **Packaging Features**

Packaging Quantity	40
Packaging Type	Tube

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources.
Solder Process Capability	Pin-in-Paste capable to 260°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**





## Also in the Series | AMPMODU Headers



PCB Connector Mounting(1)



PCB Connector Shrouds(1)



PCB Headers & Receptacles(4875)



PCB Latches, Locks & Retainers(1)



Wire-to-Board Connector Assemblies & Housings(5)

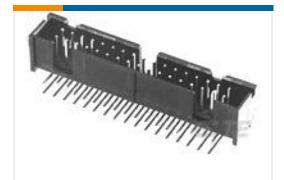


Wire-to-Board Connector Contacts(65)

## Customers Also Bought



TE Part #1-746610-4
16 DIP PLUG, 100CL, LEAD FREE



TE Part #5103310-1 A/L LOW PRO HDR 10P RA BLACK



TE Part #1-1393239-9 RT114730







TE Part #6-534206-2 24 MODII VRT DR CE 100/115



TE Part #1-338068-0 MICRO-MATCH FTE,10P



## **Documents**

**Product Drawings** 

30 MODII 2PC HDR DR SHRD .100, ROHS

English

#### **CAD Files**

Customer View Model ENG\_CVM\_6-102567-3\_N3.3d\_igs.zip

PCB Mount Header, Vertical, Board-to-Board, 30 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers



English

**Customer View Model** 

ENG\_CVM\_6-102567-3\_N3.3d\_stp.zip

English

3D PDF

3D

3D PDF

English

**Customer View Model** 

ENG\_CVM\_6-102567-3\_N3.2d\_dxf.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

AMPMODU\_INTERCONNECTION\_SYSTEM\_SECTION5\_CONT

English